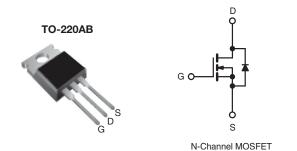


COMPLIANT

## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	10	100			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 5.0 V 0.16				
Q <sub>g</sub> (Max.) (nC)	2	28			
Q <sub>gs</sub> (nC)	3.8				
Q <sub>gd</sub> (nC)	14				
Configuration	Sir	Single			



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(on)}$  Specified at  $V_{GS} = 4 V$  and 5 V
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRL530PbF	
Lead (PD)-life	SiHL530-E3	
SnPb	IRL530	
SILD	SiHL530	

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ss otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		$V_{DS}$	100	V		
Gate-Source Voltage			$V_{GS}$	± 10	1 V	
Continuous Drain Current	V at 5.0.V	$V_{GS}$ at 5.0 V $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$	I <sub>D</sub>	15		
Continuous Drain Current	V <sub>GS</sub> at 5.0 V			11	Α	
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	60	1		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	290	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	15	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	8.8	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$		$P_{D}$	88	W		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	- °C		
Soldering Recommendations (Peak Temperature) for 10 s			-			300 <sup>d</sup>
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N · m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 1.9 mH,  $R_g$  = 25  $\Omega$   $I_{AS}$  = 15 A (see fig. 12).
- c.  $I_{SD} \le 15$  A,  $dI/dt \le 140$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 1\bar{7}5$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7		

PARAMETER	SYMBOL	TEST (	TEST CONDITIONS		TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I <sub>D</sub> = 1 mA	-	0.14	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_0$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	2.0	V
Gate-Source Leakage	I <sub>GSS</sub>	Vo	$GS = \pm 10$	-	-	± 100	nA
Zava Cata Valtaga Dyain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	-	25	
Zero Gate Voltage Drain Current		$V_{DS} = 80 \text{ V}, V_{0}$	<sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Data Carana Car Olata Basistana		V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 9.0 A <sup>b</sup>	-	-	0.16	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	I <sub>D</sub> = 7.5 A <sup>b</sup>	-	-	0.22	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 50$	0 V, I <sub>D</sub> = 9.0 A <sup>b</sup>	6.4	-	-	S
Dynamic		1		,			
Input Capacitance	C <sub>iss</sub>	V	0 V	-	930	-	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	250	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 ľ	MHz, see fig. 5	-	57	-	
Total Gate Charge	Qg			-	-	28	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 5.0 \text{ V}$	$I_D = 15 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and $13^b$	-	-	3.8	nC
Gate-Drain Charge	Q <sub>gd</sub>		See fig. 6 and 16	-	-	14	
Turn-On Delay Time	t <sub>d(on)</sub>		1	-	4.7	-	
Rise Time	t <sub>r</sub>	V 5	50 V I <sub>-</sub> - 15 Δ	-	100	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 12 \Omega, R_D$	$_{0} = 32 \Omega$ , see fig. 10 <sup>b</sup>	-	22	-	ns
Fall Time	t <sub>f</sub>	$V_{DD} = 50 \text{ V}, I_D = 15 \text{ A},$		-			
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>	package and ce die contact	nter of	-	7.5	-	nH
Drain-Source Body Diode Characteristic	s					•	
Continuous Source-Drain Diode Current	IS	MOSFET symbol showing the		-	-	15	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction did	ode	-	-	60	A
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>5</sub>	$_{S} = 15 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 25 °C !	15 A, dl/dt = 100 A/µsb	-	150	200	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	1J = 23 O, IF =	10 A, αι/αι = 100 A/μS <sup>5</sup>	-	0.93	1.4	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-	on time is negligible (turr	n-on is do	minated b	y L <sub>S</sub> and	L <sub>D</sub> )

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

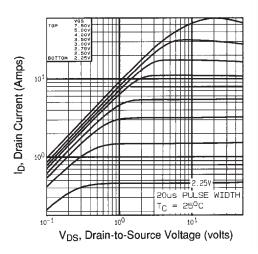


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

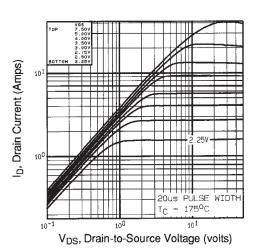


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

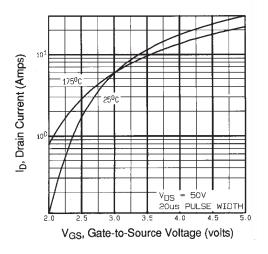


Fig. 3 - Typical Transfer Characteristics

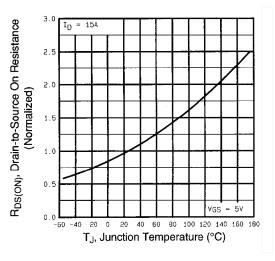


Fig. 4 - Normalized On-Resistance vs. Temperature



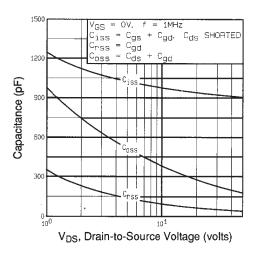


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

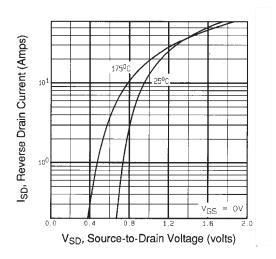


Fig. 7 - Typical Source-Drain Diode Forward Voltage

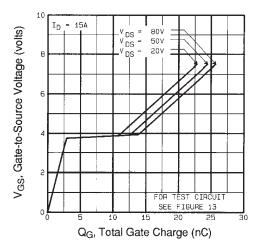


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

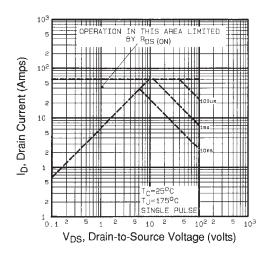


Fig. 8 - Maximum Safe Operating Area





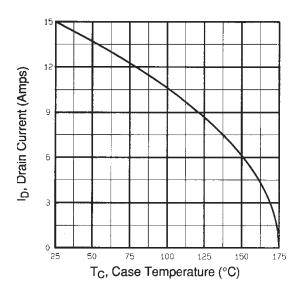


Fig. 9 - Maximum Drain Current vs. Case Temperature

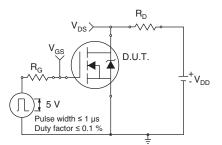


Fig. 10a - Switching Time Test Circuit

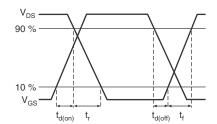


Fig. 10b - Switching Time Waveforms

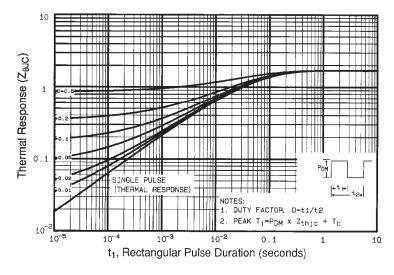


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



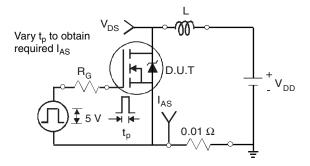


Fig. 12a - Unclamped Inductive Test Circuit

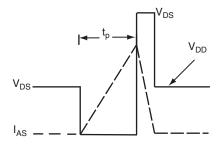


Fig. 12b - Unclamped Inductive Waveforms

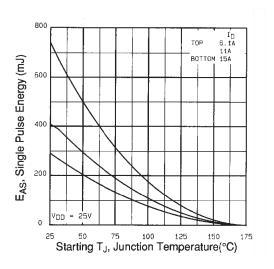


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

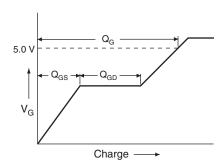


Fig. 13a - Basic Gate Charge Waveform

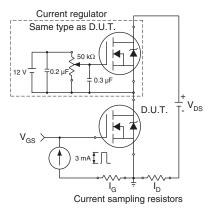
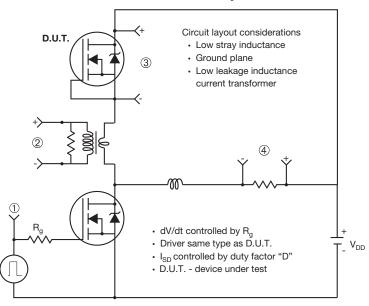


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



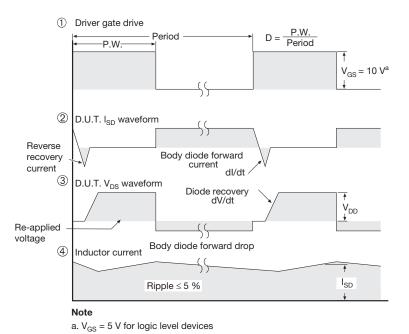


Fig. 14 - For N-Channel

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## TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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